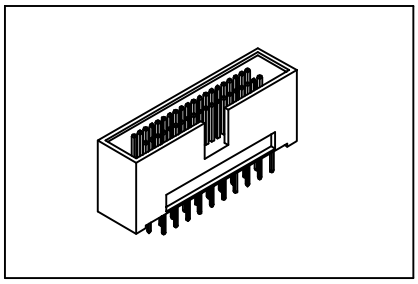
Box Header 1.27mmX2.54mm(0.050"X0.100")

GXCON



Material:

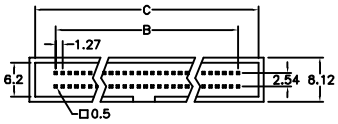
Housing: 30% Glass filled PBT UL94V-0.
Contacts: Brass.
Plating: Gold plated over nickel.
Tin plated over nickel.
Selective gold plated: Gold plated on mating area and tin plated on solder tail.

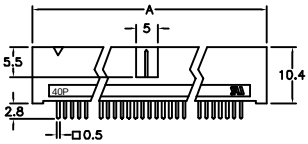
Electrical Characteristics:

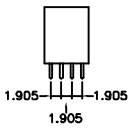
Current Rating: 0.5 AMP.
Insulator Resistance: 5000MΩmin. at DC 500V.
Contact Resistance: 20mΩmax. at DC 100mA.
Operating Temperature: -55°C~+105°C.

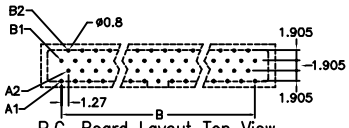
Features:

* Straight type.
* Fully shrouded offers excellent protection.
* 4 row 1.27mm(0.05") zigzag PCB Layout.
* Choices of 20,26,32,34,40,50,52,60,68,80,100 pin.

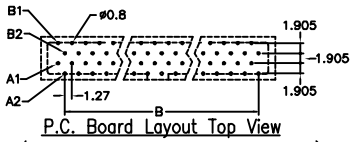








P.C. Board Layout Top View
(26,34,50 Position)



P.C. Board Layout Top View
(20,32,40,52,60,68,80,100 Position)

Position	Dimension		
	A	B	C
20	20.95	11.43	18.75
26	24.76	15.24	22.56
32	28.57	19.05	26.37
34	29.84	20.32	27.64
40	33.65	24.13	31.45
50	40.00	30.48	37.80
52	41.27	31.75	39.07
60	46.35	36.83	44.15
68	51.43	41.91	49.23
80	59.05	49.53	56.85
100	71.75	62.23	69.55

Ordering information

BX25-	100	1	1	B
Series	No. of Pin Count	3: Selective Gold Plated 1: Gold Plated 2: Tin Plated	1: Straight	B: Black *Y: Grey

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